MA4ZD03

Silicon epitaxial planar type

For high speed switching For small type power supply For DC/DC converter

■ Features

- Two isolated elements are contained in one package, allowing high-density mounting
- $I_F = 100$ mA rectification is possible
- Optimum for high frequency rectification because of its short reverse recovery time (t_{rr})

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit	
Forward current	Single	I_{F}	100	00 mA	
	Double		75		
Peak forward	Single	I_{FM}	300	mA	
current	Double		225		
Non-repetitive peak	Single	I _{FSM}	1	A	
forward surge current *Double			0.75	والم	
Reverse voltage		V_R	45	SV .	
Repetitive peak reverse voltage		V _{RRM}	45	O V	
Junction temperature		Tj	125	°C	
Storage temperature		T_{stg}	-55 to +125	% °C (√	

Note) *: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

Package

- Code SMini4-F1
- Pin Name

1: Anode 1 3: Cathode 2 2: Anode 2 4: Cathode 1

Marking Symbol: M5A

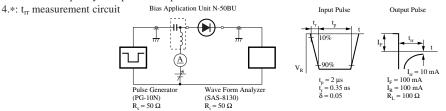
■ Internal Connection

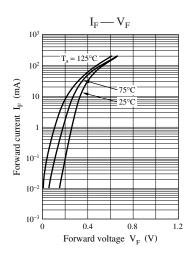


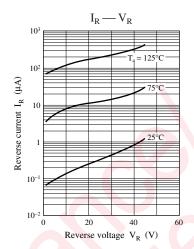
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

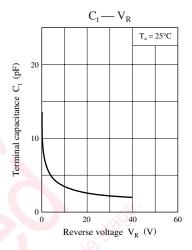
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current	I_R	$V_R = 40 \text{ V}$			5	μΑ
Forward voltage	V _F	I _F = 100 mA		0.54	0.60	V
Terminal capacitance	C _t	$V_R = 0 \text{ V, f} = 1 \text{ MHz}$		12	18	pF
Reverse recovery time *	t _{rr}	$I_F = I_R = 100 \text{ mA}$		1.2		ns
		$I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$				

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
 - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
 - 3. Absolute frequency of input and output is 250 MHz.









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